R58, Class X1, THB Grade IIIB, 600 VAC, 110°C (Automotive Grade)



Overview

The R58 is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material meeting the requirements of UL 94 V-0.

Automotive Grade devices meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.

Applications

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X1 safety classification. Typical applications include Industrial, Solar inverter output EMI filtering and Automotive HV DC bus filtering.

Benefits

- Approvals: ENEC, UL, cUL (in progress)
- Class X1 (IEC 60384-14)
- THB Grade IIIB: 85°C, 85% RH, 1,000 hours at 600 VAC acc. to IEC 60384-14
- THB Grade IIIB: 85°C, 85% RH, 1,000 hours at 1,200 VDC acc. to IEC 60384-14
- · Low Halogen Content according to JS709C
- Rated AC voltage: 600 VAC 50/60 Hz
- Rated DC voltage: 1,200 VDC
- Capacitance range: 0.01 8.2 μF
- Lead spacing: 15.0 52.5 mm
- Capacitance tolerance: ±20%, ±10%
- Climatic category 40/110/56, IEC 60068-1
- Tape and reel in accordance with IEC 60286-2
- RoHS compliant and lead-free terminations
- Operating temperature range of -40°C to +110°C
- 100% screening factory test at 3,000 VDC
- Self-healing properties
- · Automotive (AEC-Q200) grade





Customer Part Number

R58	6	I	2470	00	T0	M
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X1, Metallized Polypropylene	6 = 600	I = 15.0 N = 22.5 R = 27.5 W = 37.5 Y = 52.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	T0 T1	K = ±10% M = ±20%



Ordering Options Table

Lead Spacing Nominal (mm)	Type of Leads and Packaging	LL Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4.0 +2/-0	00
	Pizza Pack – Short Leads	4.0 +2/-0	BB
	Ammo Pack	H ₀ = 18.5 ±0.5	DQ ¹
	Other Lead and Packaging Options		
45	Tape & Reel (Large Reel)	H ₀ = 18.5 ±0.5	СК
15	Tape & Reel (Standard Reel)	$H_0 = 18.5 \pm 0.5$	GY ¹
22.5	Bulk (Bag)² – Short Leads	2.7 +0.5/-0	JA
	Bulk (Bag)² – Short Leads	3.5 +0.5/-0	JB
	Bulk (Bag)² – Short Leads	4.0 +0.5/-0	JE
	Bulk (Bag)² – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/ -0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Ctandard Land and Dackseine Ontions		
	Standard Lead and Packaging Options		00
	Bulk (Tray) – Short Leads	4.0 +2/-0 4.0 +2/-0	00
	Pizza Pack - Short Leads		BB CK ¹
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	CK.
	Other Lead and Packaging Options	0.7.05/.0	
27.5	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
	Bulk (Tray) - Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) - Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50

 $^{{\}it 1\ Not\ for\ all\ sizes,\ see\ "Packaging\ Quantities"\ table}.$

² For lead spacing 22.5 case sizes \geq 8.5*17*26.5 the parts are packed in Pizza box 335*320*34 mm.



Ordering Options Table cont.

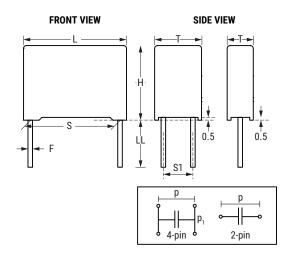
Lead Spacing Nominal (mm)	Type of Leads and Packaging	LL Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Pizza Pack – Short Leads	4.0 +2/-0	00
	Other Lead and Packaging Options		
	Pizza Pack – Short Leads	2.7 +0.5/-0	JA
37.5	Pizza Pack – Short Leads	3.5 +0.5/-0	JB
07.0	Pizza Pack – Short Leads	4.0 +0.5/-0	JE
	Pizza Pack – Short Leads	3.2 +0.3/-0.2	JH
	Pizza Pack – Long Leads	18 ±1	JM
	Pizza Pack – Long Leads	30 +5/-0	40
	Pizza Pack – Long Leads	25 +2/-1	50
52.5	Standard Lead and Packaging Options		
02.0	Pizza Pack – Short Leads	4.0 +2/-0	00

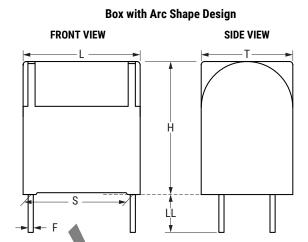
¹ Not for all sizes, see "Packaging Quantities" table.

² For lead spacing 22.5 case sizes \geq 8.5*17*26.5 the parts are packed in Pizza box 335*320*34 mm.



Dimensions - Millimeters





	S	S	1	•	Γ		<u> </u>		L		F
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
15.0	±0.4	-	-	5.0	+0.3/-0.5	11.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	6.0	+0.3/-0.5	12.0	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	7.5	+0.3/-0.5	13.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	8.5	+0.3/-0.5	14.5	+0.3/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	-	-	10.0	+0.3/-0.5	16.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	-	-	11.0	+0.3/-0.5	19.0	+0.3/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	6.0	+0.3/-0.5	15.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	7.0	+0.3/-0.5	16.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	-	8.5	+0.3/-0.5	17.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4	-	A-7	10.0	+0.3/-0.5	18.5	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4			11.0	+0.3/-0.5	20.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
22.5	±0.4			13.0	+0.3/-0.5	22.0	+0.3/-0.5	26.5	+0.5/-0.5	0.8	±0.05
27.5	±0.4			11.0	+0.3/-0.7	20.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4		-	13.0	+0.3/-0.7	22.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	14.0	+0.3/-0.7	28.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	18.0	+0.3/-0.7	33.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
27.5	±0.4	-	-	22.0	+0.3/-0.7	37.0	+0.3/-0.7	32.0	+0.5/-0.7	0.8	±0.05
37.5	±0.4	-	-	11.0	+0.3/-0.7	22.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	13.0	+0.3/-0.7	24.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	16.0	+0.3/-0.7	28.5	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	19.0	+0.3/-0.7	32.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	20.0	+0.3/-0.7	40.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	24.0	+0.3/-0.7	44.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
37.5	±0.4	-	-	30.0	+0.3/-0.7	45.0	+0.3/-0.7	42.0	+0.5/-0.7	1.0	±0.05
52.5	±0.4	20.3	±0.4	30.0	+1.2/-1.2	45.0	+1.2/-1.2	57.5	+1.2/-1.2	1.2	±0.05
52.5	±0.4	20.3	±0.4	35.0	+1.2/-1.2	50.0	+1.2/-1.2	57.5	+1.2/-1.2	1.2	±0.05
52.5*	±0.4	20.3	±0.4	45.0	+1.2/-1.2	56.0	+1.2/-1.2	57.5	+1.2/-1.2	1.2	±0.05
	Note: See the Ordering Options Table for lead length (LL) options.										

^{*} Box with Arc Shape Design



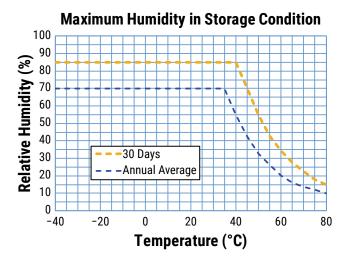
Performance Characteristics

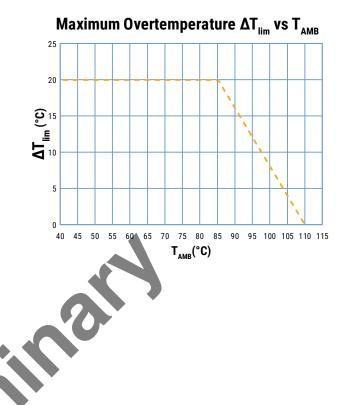
Dielectric	Polypropylene film				
Plates	Metal layer deposited by evaporation under vacuum				
Winding	Non-inductive type				
Leads	Tinned wire				
Protection	Plastic case, thermosetting res	in-filled. Box material is solve	nt resistant and flame retarda	nt according to UL94.	
Related Documents	IEC 60384-14, EN 60384-14				
Rated Voltage V _R	600 VAC (50/60 Hz) / 1,200 \	/DC			
Capacitance Range	0.01 - 8.2 μF				
Capacitance Values	E6 series (IEC 60063) measu	red at 1 kHz and +20 ±1°C			
Capacitance Tolerance	±10%, ±20%				
Temperature Range	-40°C to 110°C		4		
Climatic Category	40/110/56 IEC 60068-1				
	Storage time: ≤ 24 months fr	om the date marked on the	abel package		
	Average relative humidity per year ≤ 70%				
Storage Conditions	RH ≤ 85% for 30 days random	nly distributed throughout th	ne yéar		
	Dew is absent	440			
	Temperature: -40 to 80°C (se	ee "Maximum Humidity in S	torage Conditions" graph be	elow)	
Approvals	ENEC, UL, cUL (in progress)				
		Maximum Values	at +25°C ±5°C		
Dissipation Factor (tanδ) at 1 kHz	Pitch = 15 mm	Pitch = 22.5 or 27.5 mm	Pitch = 37.5 or 52.5 mm		
UV T IVIZ	0.4%	0.3%	0.2%		
Test Voltage Between Terminations	The 100% screening factory test is carried out at 3,000 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. It is not permitted to repeat this test as there is a risk to damage the capacitor. KEMET is not liable in such case for any failures.				
		Measured at +25°C ±5°C, ac	ccording to IEC 60384-2		
		Minimum Values Be	tween Terminals		
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 μF	
	100 VDC	1 minute	\geq 1 • 10 ⁵ MΩ (≥ 5 • 10 ⁵ MΩ)*	≥ 30,000 MΩ • μF (≥ 150,000 MΩ • μF)*	

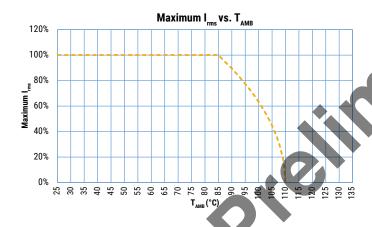
^{*}Typical Value



Performance Characteristics cont.







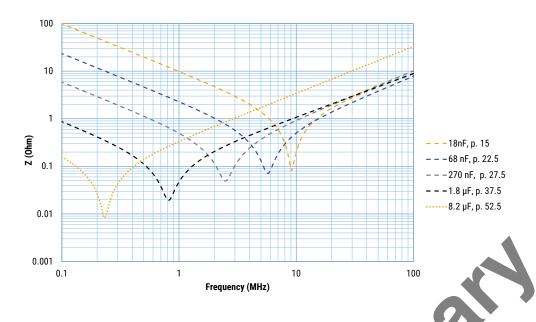
 $T_{\text{\tiny AMB}}$ is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in °C.

Qualification

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.



Impedance Graph

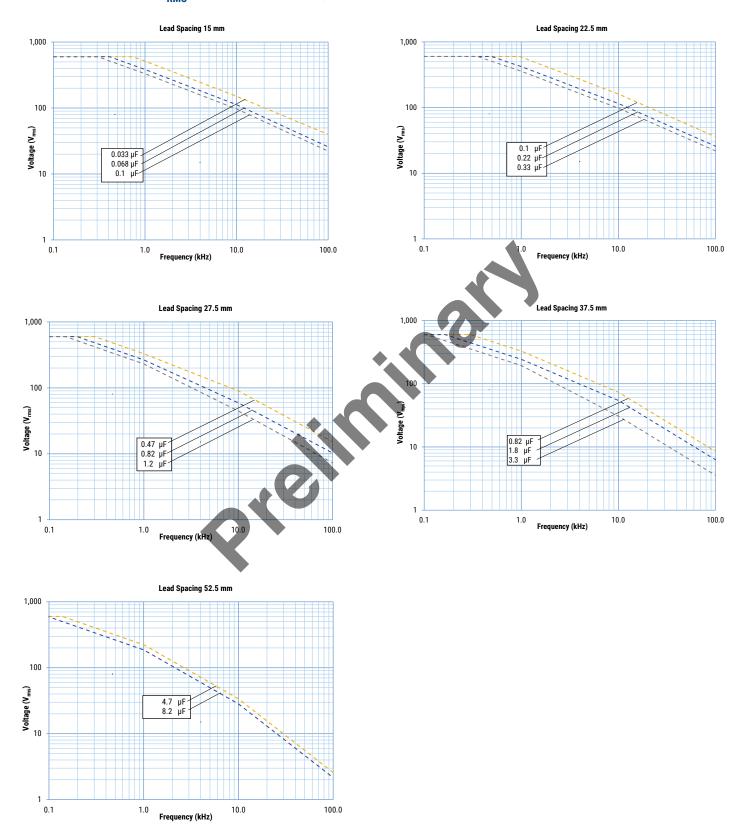


Environmental Test Data

Test	IEC Publication	Procedure
Endurance	IEC 60384-14	1.25 x V _R VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Endurance	IEC 60384-14	1.25 x 1200 VDC, 1,000 hours at upper rated temperature
Vibration	MIL-STD-202 Method 204	5 G for 20 minutes, 12 cycles each of 3 orientations. Use 8" X 5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from $10 - 2,000$ Hz.
Mechanical Shock	MIL-STD-202 Method 213	Figure 1 of Method 213. Condition C
Temperature Cycling	JESD22-Method JA-104	1,000 cycles (-40°C to 110°C) Note: Measurement at 24 ±4 hours after test conclusion. 30 minute maximum dwell time at each temperature extreme. 1 minute maximum transition time.
Active Flammability	IEC 60384-14	V _R + 20 surge pulses at 4 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle Flame Test
Biased Humidity	According to Grade IIIB	85°C/85% RH and 600 VAC, 1,000 hours Capacitance change (Δ C/C): \leq 10% Dissipation factor change (Δ tan δ): \leq 24 * 10-3 (at 10 kHz) for C \leq 1 μF Dissipation factor change (Δ tan δ): \leq 15 * 10-3 (at 1 kHz) for C > 1 μF Insulation resistance Rins or time constant τ = CR Rins: \geq 50% of initial limit
Biased Humidity	According to Grade IIIB	85°C/85% RH and 1200 VDC, 1,000 hours Capacitance change (Δ C/C): \leq 10% Dissipation factor change (Δ tan δ): \leq 24 * 10–3 (at 10 kHz) for C \leq 1 μF Dissipation factor change (Δ tan δ): \leq 15 * 10–3 (at 1 kHz) for C > 1 μF Insulation resistance Rins or time constant τ = CR Rins: \geq 50% of initial limit

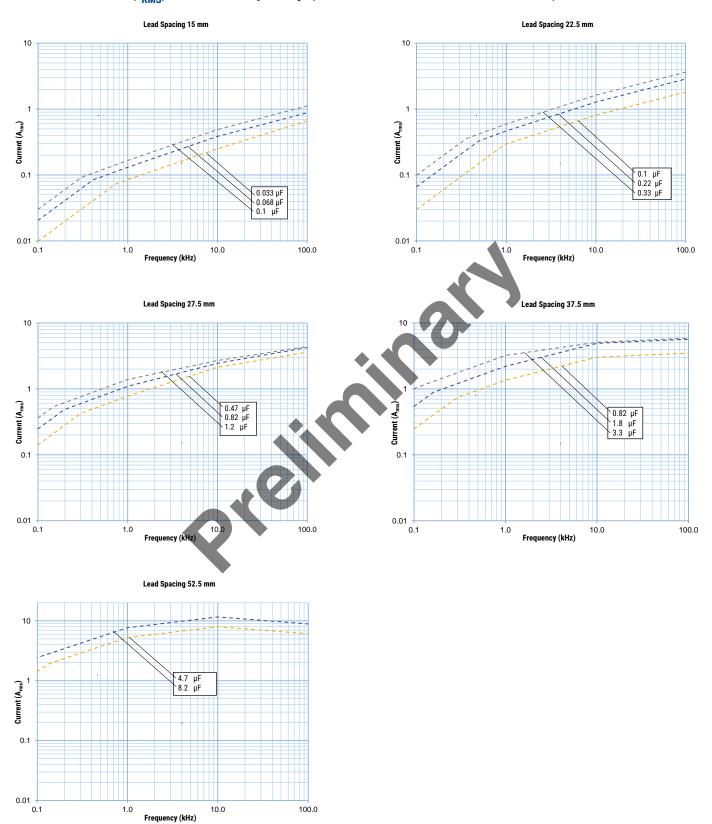


Maximum Voltage (V_{RMS}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85 °C)





Maximum Current (I_{RMS}) Versus Frequency (Sinusoidal Waveform/Th ≤ 85°C)





Environmental Compliance

All KEMET EMI capacitors are RoHS compliant.





Approvals

Certification Body	Mark	Specification	File Number
IMQ S.p.A.	I	EN/IEC 60384-14	In Progress
UL	c FL us	UL 60384-14 and CAN/ CSA-E60384-14	In Progress
сос	Cec	IEC 60384-14	In Progress



Table 1 - Ratings & Part Number Reference

Capacitance	Dime	nsions i	n mm	Lead	dV/dt	KEMET	Customer
Value (µF)	Т	Н	L	Spacing (S)	(V/µs)	Part Number	Part Number
0.01	5.0	11.0	18.0	15.0	600	586I2100(1)T0(2)	R586I2100(1)T0(2)
0.012	5.0	11.0	18.0	15.0	600	586I2120(1)T0(2)	R586I2120(1)T0(2)
0.015	5.0	11.0	18.0	15.0	600	586I2150(1)T0(2)	R586I2150(1)T0(2)
0.018	6.0	12.0	18.0	15.0	600	586I2180(1)T0(2)	R586I2180(1)T0(2)
0.022	6.0	12.0	18.0	15.0	600	586I2220(1)T0(2)	R586I2220(1)T0(2)
0.027	7.5	13.5	18.0	15.0	600	586I2270(1)T0(2)	R586I2270(1)T0(2)
0.033	7.5	13.5	18.0	15.0	600	586I2330(1)T0(2)	R586I2330(1)T0(2)
0.039	7.5	13.5	18.0	15.0	600	586I2390(1)T0(2)	R586I2390(1)T0(2)
0.047	8.5	14.5	18.0	15.0	600	586I2470(1)T0(2)	R586I2470(1)T0(2)
0.056	10.0	16.0	18.0	15.0	600	586I2560(1)T0(2)	R586I2560(1)T0(2)
0.068	10.0	16.0	18.0	15.0	600	586I2680(1)T0(2)	R586I2680(1)T0(2)
0.082	11.0	19.0	18.0	15.0	600	586l2820(1)T0(2)	R586I2820(1)T0(2)
0.10	11.0	19.0	18.0	15.0	600	586I3100(1)T0(2)	R586I3100(1)T0(2)
0.047	6.0	15.0	26.5	22.5	300	586N2470(1)T0(2)	R586N2470(1)T0(2)
0.056	6.0	15.0	26.5	22.5	300	586N2560(1)T0(2)	R586N2560(1)T0(2)
0.068	6.0	15.0	26.5	22.5	300	586N2680(1)T0M	R586N2680(1)T0M
0.082	7.0	16.0	26.5	22.5	300	586N2820(1)T0(2)	R586N2820(1)T0(2)
0.10	8.5	17.0	26.5	22.5	300	586N3100(1)T0(2)	R586N3100(1)T0(2)
0.12	8.5	17.0	26.5	22.5	300	586N3120(1)T0(2)	R586N3120(1)T0(2)
0.15	10.0	18.5	26.5	22.5	300	586N3150(1)T0(2)	R586N3150(1)T0(2)
0.18	10.0	18.5	26.5	22.5	300	586N3180(1)T0(2)	R586N3180(1)T0(2)
0.22	11.0	20.0	26.5	22.5	300	586N3220(1)T0(2)	R586N3220(1)T0(2)
0.27	13.0	22.0	26.5	22.5	300	586N3270(1)T0(2)	R586N3270(1)T0(2)
0.33	13.0	22.0	26.5	22.5	300	586N3330(1)T0M	R586N3330(1)T0M
0.22	11.0	20.0	32.0	27.5	225	586R3220(1)T0(2)	R586R3220(1)T0(2)
0.27	13.0	22.0	32.0	27.5	225	586R3270(1)T0(2)	R586R3270(1)T0(2)
0.33	13.0	22.0	32.0	27.5	225	586R3330(1)T0(2)	R586R3330(1)T0(2)
0.39	14.0	28.0	32.0	27.5	225	586R3390(1)T0(2)	R586R3390(1)T0(2)
0.47	14.0	28.0	32.0	27.5	225	586R3470(1)T0(2)	R586R3470(1)T0(2)
0.56	14.0	28.0	32.0	27.5	225	586R3560(1)T0M	R586R3560(1)T0M
0.68	18.0	33.0	32.0	27.5	225	586R3680(1)T0(2)	R586R3680(1)T0(2)
0.82	18.0	33.0	32.0	27.5	225	586R3820(1)T0(2)	R586R3820(1)T0(2)
1.0	18.0	33.0	32.0	27.5	225	586R4100(1)T0M	R586R4100(1)T0M
1.2	22.0	37.0	32.0	27.5	225	586R4120(1)T0(2)	R586R4120(1)T0(2)
0.47	11.0	22.0	42.0	37.5	150	586W3470(1)T0M	R586W3470(1)T0M
0.56	13.0	24.0	42.0	37.5	150	586W3560(1)T0(2)	R586W3560(1)T0(2)
0.68	13.0	24.0	42.0	37.5	150	586W3680(1)T0M	R586W3680(1)T0M
0.82	16.0	28.5	42.0	37.5	150	586W3820(1)T0(2)	R586W3820(1)T0(2)
1.0	16.0	28.5	42.0	37.5	150	586W4100(1)T0M	R586W4100(1)T0M
1.2	19.0	32.0	42.0	37.5	150	586W4120(1)T0(2)	R586W4120(1)T0(2)
1.5	20.0	40.0	42.0	37.5	150	586W4150(1)T0(2)	R586W4150(1)T0(2)
1.8	20.0	40.0	42.0	37.5	150	586W4180(1)T0(2)	R586W4180(1)T0(2)
2.2	24.0	44.0	42.0	37.5	150	586W4220(1)T0(2)	R586W4220(1)T0(2)
2.7	24.0	44.0	42.0	37.5	150	586W4270(1)T0(2)	R586W4270(1)T0(2)
3.3	30.0	45.0	42.0	37.5	150	586W4330(1)T0(2)	R586W4330(1)T0(2)
4.7	30.0	45.0	57.5	52.5	76	586Y4470(1)T0(2)	R586Y4470(1)T0(2)
5.6	30.0	45.0	57.5	52.5	76	586Y4560(1)T0(2)	R586Y4560(1)T0(2)
6.8	35.0	50.0	57.5	52.5	76	586Y4680(1)T0(2)	R586Y4680(1)T0(2)
8.2	45.0	56.0	57.5	52.5	76	586Y4820(1)T0(2)	R586Y4820(1)T0(2)
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	dV/dt (V/μs)	KEMET Part Number	Customer Part Number

⁽¹⁾ Insert lead and packaging code. See table for available options.

⁽²⁾ $M = \pm 20\%$, $K = \pm 10\%$



Soldering Process

The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from 183° C for SnPb eutectic alloys to $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm), and great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the recommended limits may result in degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface-mount components. Insert through-hole parts after curing the surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum of two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal before the second soldering cycle.

Manual Soldering Recommendations

The following is the recommendation for manual soldering with a soldering iron.

Recommended Soldering Temperature

Soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed 3 seconds.

Wave Soldering Recommendations

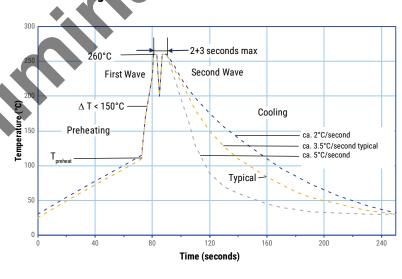


Figure 1

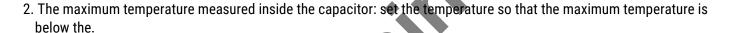


Soldering Process cont.

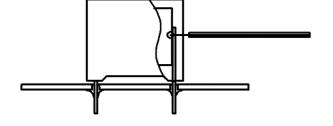
Wave Soldering Recommendations cont.

1. The table indicates the maximum set-up temperature of the soldering process. Figure 1

Dielectric Film		n Preheat erature	Maximum Peak Soldering Temperature		
Material	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	270°C	270°C	
Polypropylene	110°C	130°C	260°C	270°C	
Paper	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	160°C	270°C	270°C	



Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

Selective Soldering Recommendations

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath, as in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and then pressed against the lower surface of the board to solder the components.

The temperature profile for selective soldering is similar to the double-wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 to 10 seconds.** In selective soldering, the risk of overheating is greater than in double-wave flow soldering. Great care must be taken so that the parts do not overheat.



Mounting

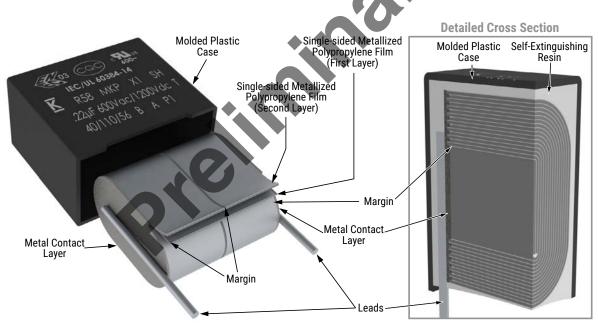
Resistance to Vibration and Mechanical Shock

AEC-Q200 Mechanical Stress Tests:

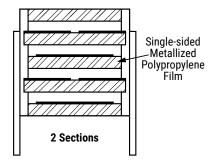
Mechanical Shock	MIL-SDT-202 Method 213	Test condition C Peak value 100 g, duration 6 ms, half-sine-wave (see MIL-HDBK for detail		
Vibration	MIL-SDT-202 Method 204	5 g for 20 minutes, 12 cycles each of 3 orientations Use 8"X5" PCB, 0.031" thick. 7 secure points on one 8" side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10 – 2,000 Hz.		

The capacitors are designed for PCB mounting. The stand-off pipes must be in good contact with the printed circuit board. The capacitors with pitch \leq 22.5 mm can be mechanically fixed by the leads, for pitch > 22.5 mm, the capacitor body has to be properly fixed (e.g. clamped or glued).

Construction

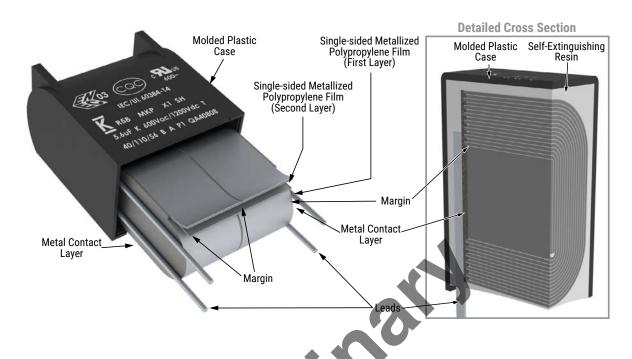


Winding Scheme



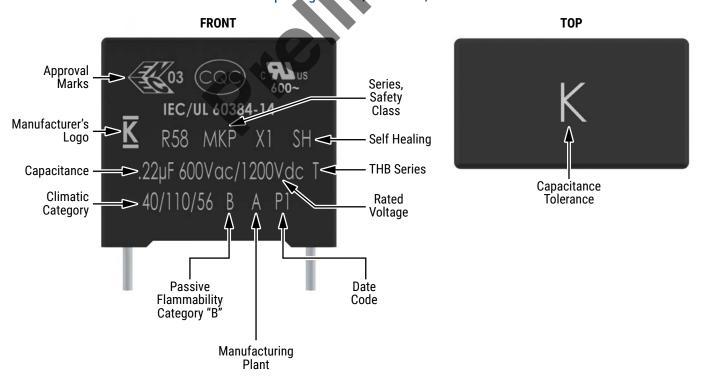


Construction cont.



Marking

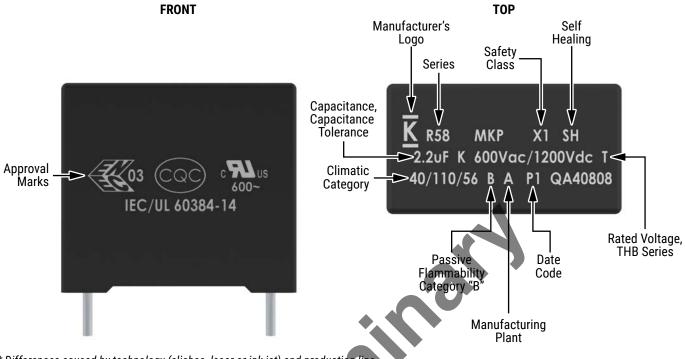
Lead Spacing 15 mm, 22.5 mm, and 27.5 mm





Marking cont.

Lead Spacing 27.5 mm alternative*, 37.5 mm and 52.5 mm in rectangular box

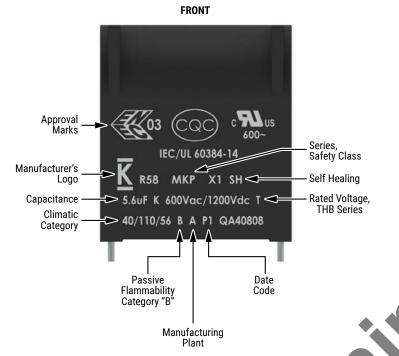


* Differences caused by technology (clichee, laser or ink jet) and production line



Marking cont.

Lead Spacing 52.5 mm in Arc Shaped Design Case



^{*} Differences caused by technology (clichee, laser or ink jet) and production line

Ma	nufacturing Date	e Code (IEC-60	062)
Year	Code	Month	Code
2020	М	January	1
2021	N	February	2
2022	Р	March	3
2023	R	April	4
2024	S	May	5
2025	T	June	6
2026	U	July	7
2027	V	August	8
2028	W	September	9
2029	X	October	0
2030	A	November	N
2031	В	December	D
2032	С		
2033	D		
2034	E		
2035	F		
2036	Н		
2037	J		
2038	K		
2039	L		
2040	М		



Packaging Quantities

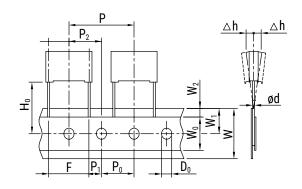
Lead Spacing	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bu Lo Lea		Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped	Pizza
	Lead And Packaging Code:			00 - JA - JB JE - JH	JM	40 - 50	GY	СК	DQ	ВВ
15	5	11	18	2,000	1,250	1,000	600	1,250	800	1,122
	6	12	18	1,750	1,000	900	500	1,000	680	935
	7.5	13.5	18	1,000	800	700	350	800	500	748
	8.5	14.5	18	1,000	650	500	300	700	440	663
	10	16	18	750	550	500	270	600	380	561
	11	19	18	450	400	350	-	500	340	510
	6	15	26.5	805	450	500	-	700	464	660
	7	16	26.5	700	450	500		550	380	564
22.5	8.5	17	26.5	468	350	300	7-	450	280	468
22.0	10	18.5	26.5	396	350	300		350	235	396
	11	20	26.5	360	200	250	- *	350	217	360
	13	22	26.5	300	150	200	-	300	_	300
	11	20	32	560	336	336	_	350	_	300
	13	22	32	480	288	288	_	300	_	250
27.5	14	28	32	352	176	176	_		_	230
	18	33	32	256	128	128	_	_	_	170
	22	37	32	168	112	112	_	_	_	150
	11	22	42	420	252	252	-	-	-	210
	13	24	42	360	216	216	-	-	-	175
	16	28.5	42	216	108	108	-	-	-	140
37.5	19	32	42	192	96	96	_	-	_	119
	20	40	42	126	84	84	_	-	_	112
	24	44	42	108	72	72	_	-	-	91
	30	45	42	90	60	60	-	-	-	77
	00	45								
52.5	30	45	57.5	-	-	-	-	-	-	27
	35	50	57.5	-	-	-	-	-	-	23
	45	56	57.5	-	-	_	_	-	-	18

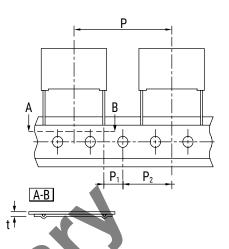


Lead Taping & Packaging (IEC 60286-2)

Figure 1 - Lead Spacing 15 mm

Figure 2 - Lead Spacing 22.5 & 27.5 mm





Taping Specification

		Dimensions (mm)				
Description	Symbol	Lead Space				
2000		15	22.5	27.5	Tol.	
		Fig. 2	Fig. 3	Fig. 3		
Lead Wire Diameter	d	0.6-0.8	0.8	0.8	±0.05	
Taping Lead Space	Р	25.4	38.1	38.1	±1	
Feed Hole Lead Space *	P_0	12.7	12.7	12.7	±0.2 **	
Centering of the Lead Wire	P ₁	5.2	7.8	5.3	±0.7	
Centering of the Body	P ₂	12.7	19.05	19.05	±1.3	
Lead Spacing (Pitch) ***	F	15	22.5	27.5	+0.6/-0.1	
Component Alignment	Δh	0	0	0	±2	
Height of Component from Tape Center	H ₀ ****	18.5	18.5	18.5	±0.5	
Carrier Tape Width	W	18	18	18	+1/-0.5	
Hold Down Tape Width	W_{0}	10	10	10	Minimum	
Hole Position	W_1	10	10	10	±0.5	
Hold Down Tape Position	W ₂	3	3	3	Maximum	
Feed Hole Diameter	D_{o}	4	4	4	±0.2	
Total Tape Thickness	t	0.7	0.7	0.7	±0.2	

^{* 15} mm also available

^{**} Maximum of 1 mm on 20 lead spaces

^{***} Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

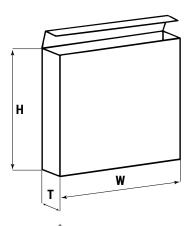
^{****} H_0 = 16.5 mm is available upon request



Lead Taping & Packaging (IEC 60286-2) cont.

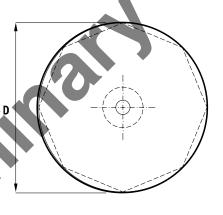
Ammo Specifications

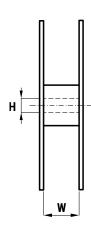
Dimensions (mm)						
Н	W	Т				
360	340	59				



Reel Specifications

Reel Size	Dimensions (mm)				
Reel Size	D	Н	W		
Standard	355	30	EE Maximum		
Large	500	25	55 Maximum		







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